# imall

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# Supertex inc.



# P-Channel Enhancement-Mode Vertical DMOS FET

#### Features

- Free from secondary breakdown
- Low power drive requirement
- Ease of paralleling
- ► Low C<sub>ISS</sub> and fast switching speeds
- High input impedance and high gain
- Excellent thermal stability
- Integral source-to-drain diode

### Applications

- Motor controls
- Converters, amplifiers, and switches
- Power supply circuits
- Drivers (relays, hammers, solenoids, lamps, memories, displays, bipolar transistors, etc.)

## **Ordering Information**

Part Number	Package Option	Packing		
VP2206N2-G	TO-39	500/Bag		
VP2206N3-G	TO-92	1000/Bag		
VP2206N3-G P002				
VP2206N3-G P003				
VP2206N3-G P005	TO-92	2000/Reel		
VP2206N3-G P013				
VP2206N3-G P014				

-G denotes a lead (Pb)-free / RoHS compliant package.

Contact factory for Wafer / Die availablity. Devices in Wafer / Die form are lead (Pb)-free / RoHS compliant.

#### **Absolute Maximum Ratings**

Value
BV <sub>DSS</sub>
BV <sub>DGS</sub>
±20V
-55°C to +150°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these conditions is not implied. Continuous operation of the device at the absolute rating level may affect device reliability. All voltages are referenced to device ground.

## **Typical Thermal Resistance**

Package	$\boldsymbol{\theta}_{_{ja}}$
TO-39	N/A
TO-92	132°C/W

#### **General Description**

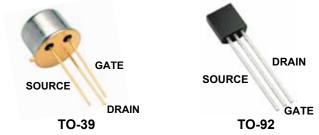
The Supertex VP2206 is an enhancement-mode (normallyoff) transistor that utilizes a vertical DMOS structure and Supertex's well-proven silicon-gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors, and the high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally-induced secondary breakdown.

Supertex's vertical DMOS FETs are ideally suited to a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance, and fast switching speeds are desired.

#### Product Summary

$BV_{DSS}/BV_{DGS}$	R <sub>DS(ON)</sub> (max)	l <sub>D(ON)</sub> (min)
-60V	0.9Ω	-4.0A

# Pin Configuration

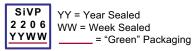


# Product Marking



Package may or may not include the following marks: Si or 🎲

TO-39



Package may or may not include the following marks: Si or

TO-92

# **VP2206**

#### **Thermal Characteristics**

Package	Ι <sub>D</sub> (continuous) <sup>†</sup>	Ι <sub>D</sub> (pulsed)	Power Dissipation @T <sub>c</sub> = 25°C		I <sub>DRM</sub>
TO-39	-750mA	-8.0A	0.36W	-750mA	-8.0A
TO-92	-640mA	-4.0	0.74W	-640mA	-4.0

Notes:

*†*  $I_{D}$  (continuous) is limited by max rated  $T_{i}$ .

#### Electrical Characteristics (T<sub>4</sub> = 25°C unless otherwise specified)

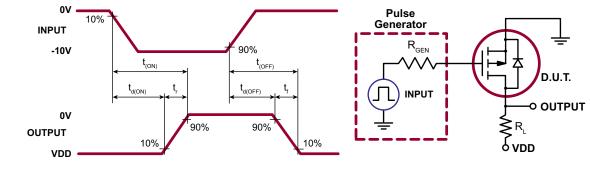
Sym	Parameter	Min	Тур	Max	Units	Conditions
BV <sub>DSS</sub>	Drain-to-source breakdown voltage	-60	-	-	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = -10mA
V <sub>GS(th)</sub>	Gate threshold voltage	-1.0	-	-3.5	V	$V_{GS} = V_{DS}, I_{D} = -10 \text{mA}$
$\Delta V_{GS(th)}$	Change in $V_{GS(th)}$ with temperature	-	-4.3	-5.5	mV/ºC	$V_{GS} = V_{DS}, I_{D} = -10 \text{mA}$
I <sub>GSS</sub>	Gate body leakage	-	-1.0	-100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
		-	-	-50	μA	$V_{GS}$ = 0V, $V_{DS}$ = Max Rating
I <sub>DSS</sub>	Zero gate voltage drain current	-	-	-10	mA	$V_{DS} = 0.8$ Max Rating, $V_{GS} = 0V$ , $T_A = 125^{\circ}C$
	On state drain surrant	-0.85	-2.0	-		V <sub>GS</sub> = -5.0V, V <sub>DS</sub> = -25V
D(ON)	On-state drain current	-4.0	-9.0	-	Α	V <sub>GS</sub> = -10V, V <sub>DS</sub> = -25V
Р	Statia drain to source on state resistance	-	1.3	1.5	Ω	V <sub>GS</sub> = -5.0V, I <sub>D</sub> = -1.0A
R <sub>DS(ON)</sub>	Static drain-to-source on-state resistance	-	0.75	0.9		V <sub>GS</sub> = -10V, I <sub>D</sub> = -3.5A
$\Delta R_{DS(ON)}$	Change in $R_{DS(ON)}$ with temperature	-	0.85	1.2	%/°C	V <sub>GS</sub> = -10V, I <sub>D</sub> = -3.5A
G <sub>FS</sub>	Forward transductance	800	1400	-	mmho	V <sub>DS</sub> = -25V, I <sub>D</sub> = -2.0A
C <sub>ISS</sub>	Input capacitance	-	325	450		V <sub>GS</sub> = 0V,
C <sub>oss</sub>	Common source output capacitance	-	125	180	pF	$V_{\rm DS} = -25V,$
C <sub>RSS</sub>	Reverse transfer capacitance	-	30	40		f = 1.0MHz
t <sub>d(ON)</sub>	Turn-on delay time	-	4.0	15		
t <sub>r</sub>	Rise time	-	16	25	ns	$V_{DD} = -25V,$ $I_{D} = -4.0A,$
t <sub>d(OFF)</sub>	Turn-off delay time	-	16	50		$R_{GEN} = 10\Omega$
t <sub>f</sub>	Fall time	-	22	50		GEN
V <sub>SD</sub>	Diode forward voltage drop	-	-1.1	-1.6	V	V <sub>GS</sub> = 0V, I <sub>SD</sub> = -3.5A
t <sub>rr</sub>	Reverse recovery time	-	500	-	ns	V <sub>GS</sub> = 0V, I <sub>SD</sub> = -1.0A

Notes:

All D.C. parameters 100% tested at 25°C unless otherwise stated. (Pulse test: 300µs pulse, 2% duty cycle.) All A.C. parameters sample tested. 1.

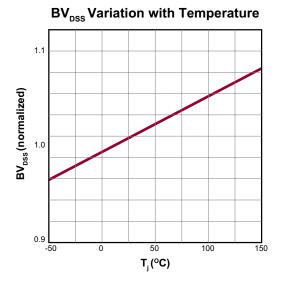
2.

#### **Switching Waveforms and Test Circuit**

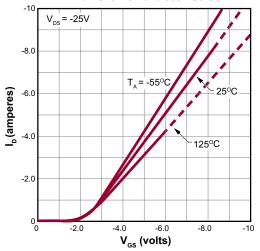


### VP2206

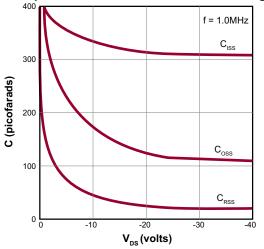
#### **Typical Performance Curves**

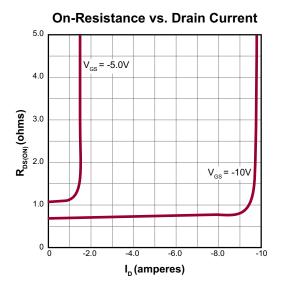


**Transfer Characteristics** 

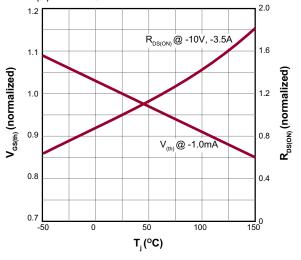


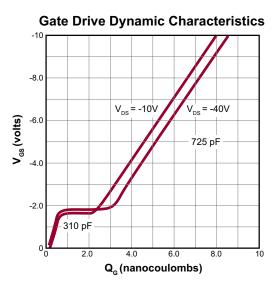
Capacitance vs. Drain-to-Source Voltage





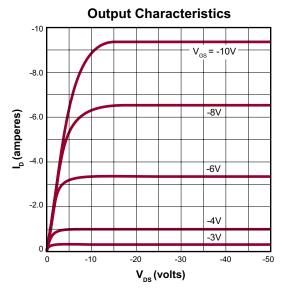
 $\mathbf{V}_{\text{\tiny (th)}} \text{and } \mathbf{R}_{\text{\tiny DS}} \text{Variation with Temperature}$ 



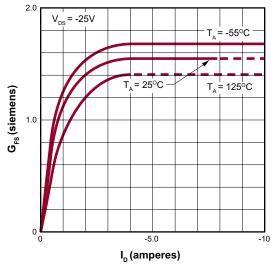


## VP2206

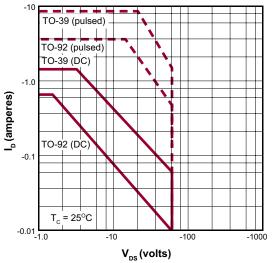
# Typical Performance Curves (cont.)

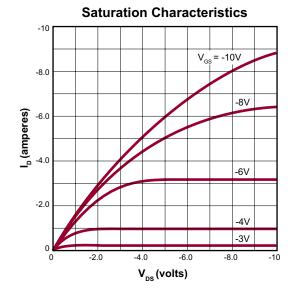


Transconductance vs. Drain Current

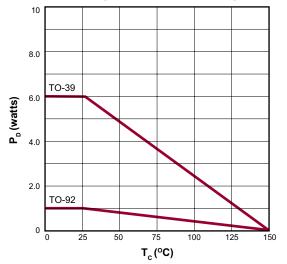


Maximum Rated Safe Operating Area

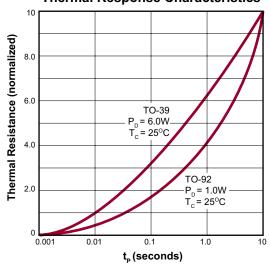




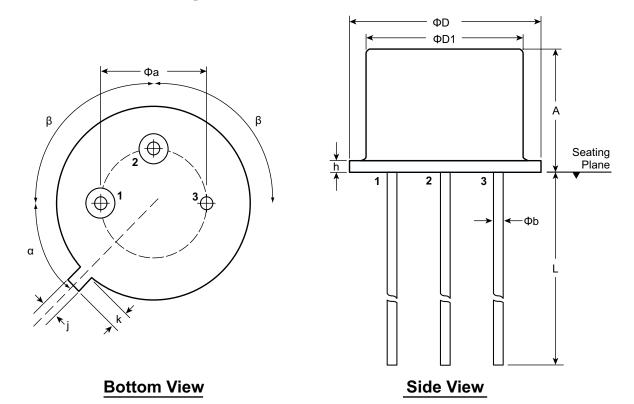
Power Dissipation vs. Case Temperature



Thermal Response Characteristics



# 3-Lead TO-39 Package Outline (N2)



Symbo	ol	α	β	Α	Фа	Φb	ΦD	<b>Φ</b> D1	h	j	k	L
Dimension (inches)	MIN		90° NOM	.240	.190	.016	.350	.315	.009	.028	.029	.500
	NOM	45° NOM		-	-	-	-	-	-	-	-	-
	MAX			.260	.210	.021	.370	.335	.125	.034	.040	.560*

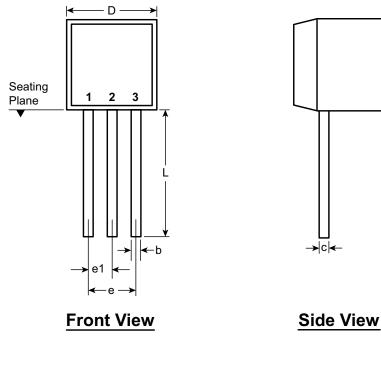
JEDEC Registration TO-39.

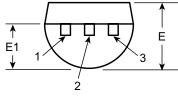
\* This dimension is not specified in the JEDEC drawing.

Drawings not to scale.

Supertex Doc. #: DSPD-3TO39N2, Version B052009.

# 3-Lead TO-92 Package Outline (N3)







Symb	ol	A	b	С	D	E	E1	е	e1	L
Dimensions (inches)	MIN	.170	.014†	.014†	.175	.125	.080	.095	.045	.500
	NOM	-	-	-	-	-	-	-	-	-
	MAX	.210	.022†	.022†	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92.

\* This dimension is not specified in the JEDEC drawing.

† This dimension differs from the JEDEC drawing.

Drawings not to scale.

Supertex Doc.#: DSPD-3TO92N3, Version E041009.

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to <u>http://www.supertex.com/packaging.html</u>.)

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